

LM5015 High Voltage Monolithic Two-Switch Forward DC-DC Regulator

General Description

dzsc.com

The LM5015 high voltage switch mode regulator features all the functions necessary to implement efficient high voltage Two-Switch Forward and Two-Switch Flyback regulators, using a minimum of external components. This easy to use regulator integrates high side and low side 75 Volt N-Channel MOSFETs with a minimum 1 Amp peak current limit. The voltage across the MOSFETs employed in the two-switch topology is clamped to the input voltage, allowing the input voltage range to approach the rating of the MOSFETs. The regulator control method is based on current mode control providing inherent ease of loop compensation and line feedforward for superior rejection of input transients.

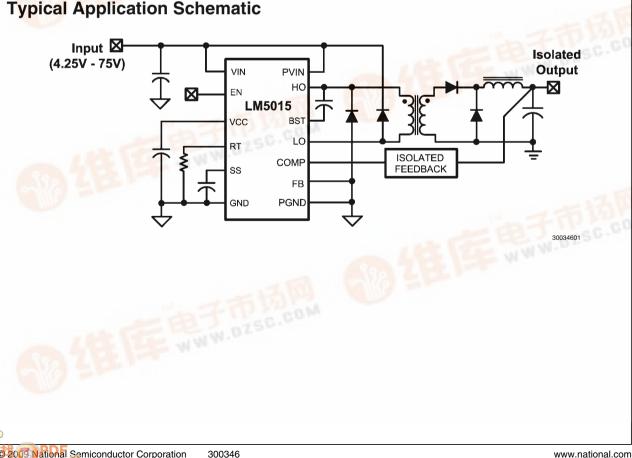
The operating frequency is set with a single resistor and is programmable up to 750 kHz. The oscillator can also be synchronized to an external clock. Additional protection features include cycle-by-cycle current limiting, thermal shutdown, under-voltage lockout and remote shutdown capability. The device is available in the TSSOP-14EP package featuring an exposed die attach pad to enhance thermal dissipation.

Features

- Dual Integrated 75V N-Channel MOSFETs
- Ultra-wide input voltage range: 4.25V to 75V
 - Integrated high voltage bias regulator
- Adjustable output voltage
- 1.5% feedback reference accuracy
- Current mode control with selectable compensation
- Wide bandwidth error amplifier
- Integrated current sensing and limiting
- 50% maximum duty cycle limit
- Single resistor oscillator programming
- Oscillator synchronization capability
- Programmable soft-start
- Enable / Under-voltage Lockout (UVLO) pin
- Thermal shutdown

Package

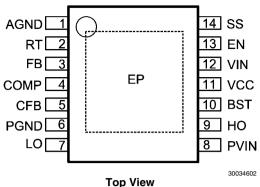
TSSOP-14EP (Exposed Pad)



M5015 High Voltage Monolithic Two-Switch Forward DC-DC Regulator

LM5015

Connection Diagram 查询"LM5015"供应商



Top View TSSOP-14 EP Package

Ordering Information

Order Number	Package Type	NSC Package Drawing	Supplied As
LM5015MH	TSSOP-14 EP		94 Units per Antistatic Tube
LM5015MHE		MXA14A	250 Units on Tape and Reel
LM5015MHX			2500 Units on Tape and Reel

Pin	Name	Description	Application Information	
1	AGND	Analog ground	Internal reference for the regulator control functions. The AGND pin and the PGND pin should be connected directly to minimize switching noise and prevent erratic operation.	
2	RT	Oscillator frequency programming and optional synchronization input	The internal oscillator is set with a resistor between this pin and the AGND pin. The recommended switching frequency range is 25KHz to 750 kHz. The RT pin can accept synchronization pulses from an external clock. A 100 pF capacitor is recommended for coupling the synchronizing clock to the RT pin.	
3	FB	Feedback input of the internal error amplifier, for non-isolated applications	This pin is connected to the inverting input of the internal error amplifier. The 1.26V reference is internally connected to the non-inverting input of the error amplifier. In isolated application using an external error amplifier, this pin should be connected to the AGND pin.	
4	COMP	Control input for the PWM comparator	Internally connected to the open drain output of the internal error amplifier. COMP pull-up is provided by an internal 5 k Ω resistor which may be used to bias an opto-coupler transistor in isolated applications.	
5	CFB	Current feedback pin	Feedback in put for high bandwidth isolated applications. An NPN cur mirror couples the external opto-coupler current to the PWM compara while maintaining a relatively constant opto-coupler voltage.	
6	PGND	Power ground	Internally connected to the current sense resistor in the source of the low side MOSFET switch.	
7	LO	Low side switch drain	The drain terminal of the internal low side power MOSFET.	
8	PVIN	Input supply pin for high side switch	Internally connected to the drain of the high side power MOSFET.	
9	НО	High side switch source	The source terminal of the high side power MOSFET.	
10	BST	High side bootstrap bias	An external capacitor is required between the BST and the HO pins. A minimum capacitor value of 0.022 μ F is recommended. The capacitor is charged from VCC via an internal diode during the power MOSFET off-time.	
11	VCC	Bias regulator output, or input for external bias supply	VCC tracks VIN up to 6.9V. At higher VIN voltages, VCC is regulated to 6.9 Volts. A 0.47μ F or greater ceramic decoupling capacitor is required on the VCC pin. An external bias voltage between 7V and 14V applied to the VCC pin will disable the internal VCC regulator, reduce internal power dissipation, and improve the converter efficiency.	
12	VIN	Analog input voltage pin	Power supply Input for the switching regulator control blocks.	
13	EN	Enable / Under-Voltage Lock- Out / Shutdown input	An external voltage divider can be used to set the input under-voltage lockout threshold. If the EN pin is left unconnected, a 6 μ A pull-up current source pulls the EN pin high to enable the regulator.	
14	SS	Soft-start	An internal 11 μ A current source charges an external capacitor connected to the SS pin to soft-start the switching regulator by gradually raising the COMP pin voltage.	
NA	EP	Exposed Pad	Exposed metal pad on the underside of the package. It is recommended to connect this pad to the PGND and AGND pins, and also to the PC board ground plane in order to improve heat dissipation.	

Absolute Maximum Ratings (Note 1)

间"I_M5015"供应该 If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

V _{IN} to AGND	76V
BST to AGND	90V
PVIN to HO, LO, PGND	76V
HO to PGND (Steady State)	-3V to 76V
LO to PGND (Steady State)	-0.3V to 76V
BST to VCC	76V
BST to HO	14V
V _{CC} , EN to AGND	14V

COMP, FB, RT, SS to AGND-0.3V to 7VPGND to AGND-0.3V to +0.3VCFB Sink Current10 mAMaximum Junction Temperature150°CStorage Temperature-65°C to + 150°CESD Rating-45°C to + 150°CHuman Body Model2 kV

Operating Ratings

V _{IN}	4.25V to 75V
Operation Junction Temperature	-40°C to + 125°C

Electrical Characteristics Limits in standard type are for $T_J = 25^{\circ}C$ only; limits in boldface type apply over the junction temperature (T_J) range of $-40^{\circ}C$ to $+ 125^{\circ}C$. Minimum and Maximum limits are guaranteed through test, design, or statistical correlation. Typical values represent the most likely parametric norm at $T_J = 25^{\circ}C$, and are provided for reference purposes only. $V_{VIN} = 48V$, $R_{BT} = 31.6 \text{ k}\Omega$ unless otherwise stated. See (Note 3).

Symbol	Parameters	Conditions	Min	Тур	Max	Units
STARTUP REGU	LATOR					
V _{VCC-REG}	VCC Regulator Output		6.35	6.85	7.25	V
	VCC Current Limit	$V_{VCC} = 6V$	20	25		mA
	VCC UVLO Threshold	VCC increasing, VIN = VCC, EN=open	3.45	3.75	4.05	V
	VCC UVLO Hysteresis	VIN = VCC, EN = open		0.15		V
	Bias Current (IIN)	V _{FB} = 1.5V		3.1	4.5	mA
۱ _Q	Shutdown Current (IIN)	$V_{EN} = 0V$		110	170	μA
EN THRESHOLD	S					
	EN Shutdown Threshold	V _{EN} increasing	0.25	0.45	0.65	V
	EN Shutdown Hysteresis			0.1		V
	EN Standby Threshold	V _{EN} increasing	1.19	1.26	1.3	V
	EN Standby Hysteresis			0.1		V
	EN Current Source			6		μA
MOSFET CHARA	ACTERSTICS	•		•	•	
	Low side MOSFET RDS(ON) plus	I _D = 0.6A		0.49	0.93	Ω
	Current Sense Resistance					
	MOSFET Leakage Current	$V_{LO} = 75V$		0.05	5	μA
	High side MOSFET RDS(ON)	I _D = 0.6A		0.45	0.90	Ω
	MOSFET Leakage Current	V _{PVIN} = 75V, V _{HO} = PGND		0.05	5	μA
	Total Gate Charge including both	$V_{VCC} = 8V$		9		nC
	Low and High side MOSFETs					
	Pre-charge Switch ON Voltage	I _D = 1 mA		0.82		V
	including series blocking diode					
CURRENT LIMIT			-	1		<u> </u>
I _{LIM}	Cycle by Cycle Current Limit		1	1.2	1.4	A
	Cycle by Cycle Current Limit Delay			130		ns
DSCILLATOR				1		
F _{SW1}	Frequency1	R _{RT} = 31.6k	180	200	220	kHz
F _{SW2}	Frequency2	R _{RT} = 15.4k	365	405	445	kHz
V _{RT-SYNC}	SYNC Threshold	V _{RT} Increasing	3.2			V
	SYNC Pulse Width Minimum	$V_{RT} > V_{RT-SYNC} + 0.5V$		15		ns

Symbol	Parameters	Conditions	Min	Тур	Max	Units
WM COMPARA	16 015"供应商	•	•	•		
	Maximum Duty Cycle			49		%
	Min On-time	V _{COMP} > V _{COMP-OS}		140		ns
	Min On-time	V _{COMP} < V _{COMP-OS}		0		ns
V _{COMP-OS}	COMP to PWM Comparator Offset		0.9	1.3	1.55	V
RROR AMPLIFI	ER	•	•	•	•	
V _{FB-REF}	Feedback Reference Voltage	Internal reference, $V_{FB} = V_{COMP}$	1.236	1.26	1.274	V
	FB Bias Current			10		nA
	DC Gain			72		dB
	COMP Sink Current	$V_{COMP} = 250 \text{mV}$	2			mA
	COMP Short Circuit Current	$V_{FB} = 0, V_{COMP} = 0$	0.9	1.2	1.5	mA
	COMP Open Circuit Voltage	$V_{FB} = 0$	4.5	5.15	5.95	V
	COMP to SW Delay			50		ns
	Unity Gain Bandwidth			4		MHz
OFT START						
	Soft-start Current Source		8	11	14	μA
	Soft-start to COMP Offset		0.3	0.5	0.7	V
HERMAL SHUT	DOWN			2		
T _{SD}	Thermal Shutdown Threshold			165		°C
	Thermal Shutdown Hysteresis			25		°C
HERMAL RESIS	TANCE					
θ_{JC}	Junction to Case			6.6		°C/W
θ _{JA}	Junction to Ambient			40		°C/W

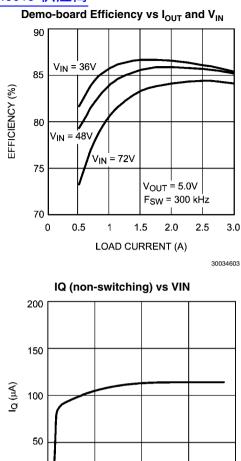
Note 1: Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is intended to be functional. For guaranteed specifications and test conditions, see the Electrical Characteristics.

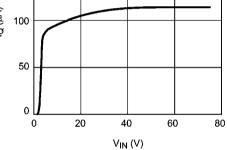
Note 2: The human body model is a 100pF capacitor discharged through a 1.5 kΩ resistor into each pin. Test Method is per JESD-22-A114.

Note 3: Min and Max limits are 100% production tested at 25°C. Limits over the operating temperature range are guaranteed through correlation using Statistical Quality Control (SQC) methods. Limits are used to calculate National's Average Outgoing Quality Level (AOQL).

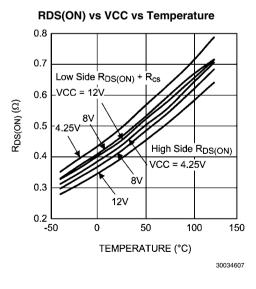


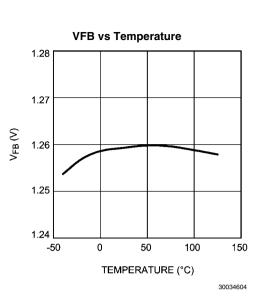
Typical Performance Characteristics 查询"LM5015"供应商



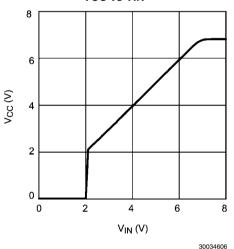


30034605

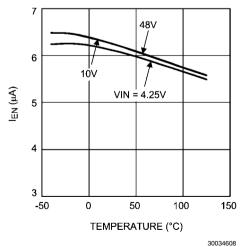


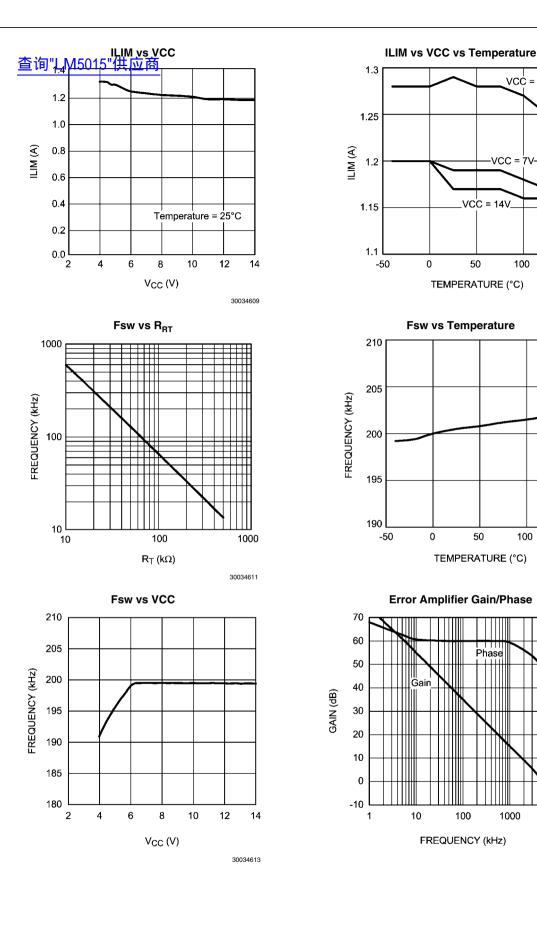






IEN vs VIN vs Temperature







VCC = 4.25V

VCC = 7V-

-30

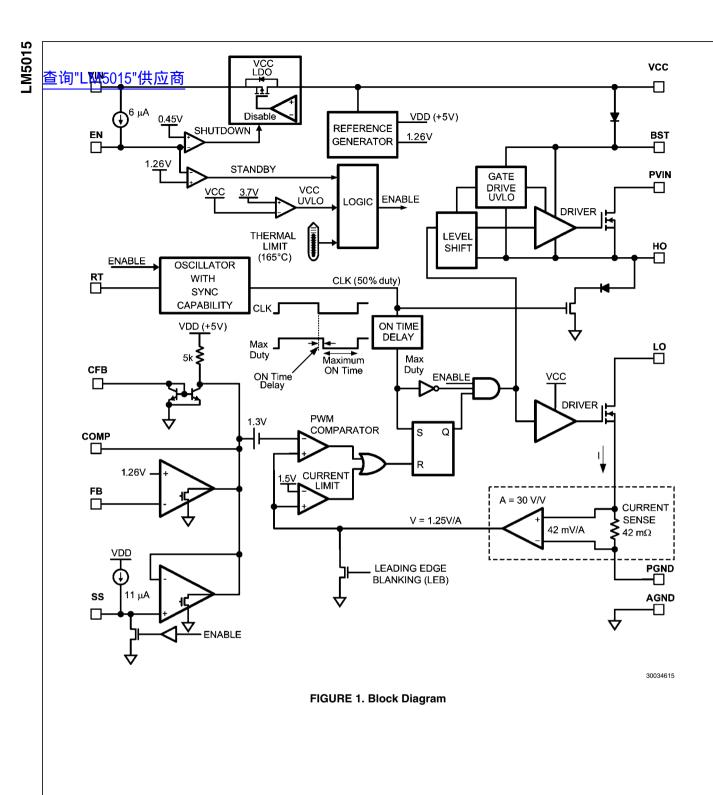
-60

-90

-120 Γ

PHASE (°)

www.national.com



Functional Description

The LMS013 high voltage switching regulator features all the functions necessary to implement an efficient power converter using a Two-Switch Forward or Two-Switch Flyback topology. The voltage across the MOSFETs employed in the two-switch topology is clamped to the input voltage, allowing the input voltage range to approach the rating of the MOSFETs. The regulator control method is based upon current mode control providing cycle-by-cycle current limit, inherent input voltage feed-forward and simple feedback loop compensation.

Referring to the functional block diagram shown in Figure1, the operating principle of the LM5015 regulator is as follows: At the beginning of each switching cycle, the oscillator sets the driver logic and turns on both the high and low side power MOSFETs to conduct current through the inductor or power transformer. The peak current in the MOSFET is controlled by the voltage at the COMP pin. The COMP voltage, which is determined by the feedback circuit, is compared with the sensed current signal of the internal low side power MOSFET. When the current signal exceeds the COMP voltage, the PWM comparator resets the driver logic, turning off both power MOSFETs. At the end of the switching cycle the driver logic is set again by the oscillator to initiate the next switching period.

The LM5015 also contains dedicated circuitry to protect the IC from abnormal operating conditions. Cycle-by-cycle current limiting prevents the power MOSFET current from exceeding 1 Amp. Thermal Shutdown circuitry holds the driver logic in reset when the die temperature reaches 165°C, and returns to normal operation when the die temperature drops by approximately 25°C. The EN pin can be used as an input voltage under-voltage lockout (UVLO) during start-up to pre-

vent operation with less than the minimum desired input voltage.

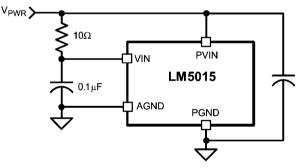
Bias Input (VIN) and Power Input (PVIN)

The LM5015 provides two separate input power pins, VIN and PVIN, allowing for flexible decoupling options. The VIN pin provides power to the low drop-out VCC bias regulator which powers all internal control blocks. The PVIN connects directly to the high side MOSFET drain.

If used with a single input source, the recommended configuration is shown in Figure 2a. Separate input pins allow the bias input (VIN) to be de-coupled from the main power input as shown. It is possible to directly connect the VIN and PVIN pins for applications with localized de-coupling capacitors.

For applications where a lower voltage auxiliary source is available, the configuration shown in Figure 2b can be used. Powering the VIN pin with a relatively low voltage auxiliary source reduces the IC power dissipation and increases the conversion efficiency, especially when the main power source for PVIN is relatively large. The VIN and PVIN pins are independent and can be separately biased at any voltages within the 4.25V to 75V recommended operating range.

In high voltage applications extra care should be taken to ensure that the VIN and PVIN pins do not exceed the Absolute Maximum Voltage Ratings of 76V. Voltage ringing on the input line during line transients that exceeds the Absolute Maximum Ratings can damage the IC. Both careful PC board layout and the use of quality bypass capacitors located close to the VIN and AGND pins, and to the PVIN to PGND pins, are essential.



(a) Analog Input Powered from the Main Power

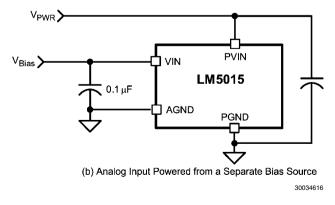


FIGURE 2. Analog and Power Input Ports

The PVIN and PGND pins are internally connected to the high and lowing power MCS FETs, respectively. When designing the PC board, the input filter capacitor should connect directly to these pins with short connection traces.

The VIN operating range is 4.25V to 75V. The current drawn into the VIN pin depends primarily on the gate charge of the internal power MOSFETs, the switching frequency, and any external load on the VCC pin. It is recommended that a small filter shown in Figure 2 be used for the VIN input to suppress transients which may occur at the input supply. This is particularly important when VIN is operated close to the maximum operating rating of the LM5015.

High Voltage VCC Regulator

The LM5015 VCC Low Drop Out (LDO) regulator allows the LM5015 to operate at the lowest possible input voltage. When power is applied to the VIN pin and the EN pin voltage is greater than 0.45V, the VCC regulator is enabled, supplying current into the external capacitor connected to the VCC pin. When the VIN voltage is between 4.25V and 6.9V, the VCC voltage is approximately equal to the VIN voltage. When the voltage on the VIN pin exceeds 6.9V, the VCC pin voltage is regulated at 6.9V. The total input operating range of the VCC LDO regulator is 4.25V to 75V.

The output of the VCC regulator is current limited to 20mA. During power-up, the VCC regulator supplies current into the required decoupling capacitor ($0.47 \ \mu$ F or greater ceramic capacitor) at the VCC pin. When the voltage at the VCC pin exceeds the VCC UVLO threshold of 3.75V and the EN pin is greater than 1.26V the PWM controller is enabled and switching begins. The controller remains enabled until VCC falls below 3.60V or the EN pin falls below 1.16V.

An auxiliary supply voltage can be applied to the VCC pin to reduce the IC power dissipation. If the auxiliary voltage is greater than 6.9V, the internal regulator will essentially shutoff, and internal power dissipation will be decreased by the VIN-VCC voltage difference times the operating current. The externally applied VCC voltage should not exceed 14V. The VCC regulator series pass MOSFET includes a body diode (see Figure 1) between VCC and VIN that should not be forward biased in normal operation. Therefore, the auxiliary VCC voltage should never exceed the VIN voltage.

High Side Bootstrap Bias

The high side bootstrap bias provides power to drive the high side power MOSFET. An external capacitor is required between the BST and the HO pins. A minimum capacitor value of 0.022 μF is recommended. The capacitor is charged from VCC via an internal diode during each power MOSFET off-time.

Oscillator

A single external resistor connected between RT and AGND pins sets the LM5015 oscillator frequency. To set a desired oscillator frequency (F_{SW}), the necessary value for the R_T resistor can be calculated from the following equation:

$$R_{T} = 32.4 \text{ k}\Omega \text{ x} \frac{200 \text{ kHz}}{F_{SW} \text{ (kHz)}} - 0.8 \text{ k}\Omega$$

The tolerance of the external resistor and the frequency tolerance indicated in the Electrical Characteristics table must be taken into account when determining the total variation of the switching frequency.

External Synchronization

The LM5015 can be synchronized to the rising edge of an external clock. Because the oscillator uses a divide-by-two circuit, the switching frequency F_{SW} in the above equation is actually half the native oscillator frequency. Therefore, in order to synchronize, the external clock must have a frequency higher than twice the free running F_{SW} set by the R_{T} resistor. The clock signal should be coupled through a 100 pF capacitor into the RT pin. A peak voltage level greater than 3.2V at the RT pin is required for detection of the sync pulse. The DC voltage across the R_T resistor is internally regulated at 1.5 volts. The negative portion of the AC voltage of the synchronizing clock is clamped to 1.5V by an amplifier inside the LM5015 with approximately 100 output impedance. Therefore, the AC pulse superimposed on the R_T resistor must have positive pulse amplitude of 1.7V or greater to successfully synchronize the oscillator. The sync pulse width measured at the RT pin should have a duration greater than 15 ns and less than 5% of the switching period. The R_T resistor is always required, whether the oscillator is free running or externally synchronized. The R_T resistor should be located very close to the device and connected directly to the RT and AGND pins of the LM5015.

Enable / Standby

The LM5015 contains a dual level Enable circuit. When the EN pin voltage is below 0.45V, the IC is in a low current shutdown mode with the VCC LDO disabled. When the EN pin voltage is raised above the 0.45V shutdown threshold but below the 1.26V standby threshold, the VCC LDO regulator is enabled, while the remainder of the IC is disabled. When the EN pin voltage is raised above the 1.26V standby threshold, all functions are enabled and normal operation begins. An internal 6 μ A current source pulls up the EN pin to activate the IC when the EN pin is left disconnected.

An external set-point resistor divider from VIN to AGND can be used to determine the minimum operating input voltage of the regulator. The divider must be designed such that the EN pin exceeds the 1.26V standby threshold when VIN is in the desired operating range. The internal 6 μ A current source should be included when determining the resistor values. The shutdown and standby thresholds have 100 mV hysteresis to prevent noise from toggling between modes. The EN pin is internally protected by a 6V Zener diode through a 1 k Ω resistor. The enabling voltage may exceed the Zener voltage, however the Zener current should be limited to less than 4 mA.

Error Amplifier and PWM Comparator

An internal high gain error amplifier generates an error signal proportional to the difference between the regulated output voltage and an internal precision reference. The output of the error amplifier is connected to the COMP pin allowing the user to add loop compensation, typically a Type II network, as illustrated in Figure 3. This network creates a pole at the origin that rolls off the high DC gain of the amplifier, which is necessary to accurately regulate the output voltage. A zero provides phase boost near the open loop unity gain frequency, and a high frequency pole attenuates switching noise. The PWM comparator compares the current sense signal from the current sense amplifier to the error amplifier output voltage at the COMP pin.

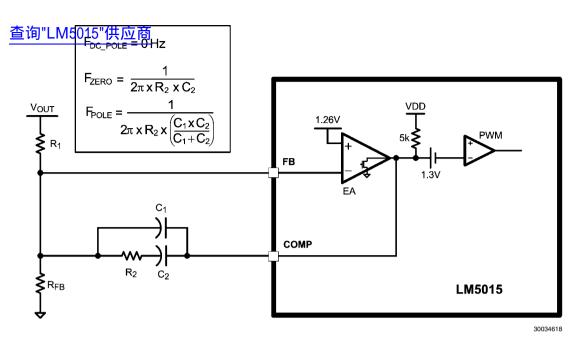


FIGURE 3. Type II Compensator

When isolation between primary and secondary circuits is required, the Error Amplifier is usually disabled by connecting the FB pin to AGND. This allows the COMP pin to be driven directly by the collector of an opto-coupler. In isolated designs the error amplifier is located on the secondary circuit and drives the opto-coupler LED. The compensation network is connected to the secondary side error amplifier. An example of an isolated regulator with an opto-coupler is shown in Figure 13.

Current Sense Amplifier

The LM5015 employs peak current mode control which also provides a cycle-by-cycle over current protection feature. An internal 42 milli-Ohm current sense resistor measures the current in the low side power MOSFET source. The sense resistor voltage is amplified 30 times to provide a 1.25V/A signal into the current limit comparator. Current limiting is initiated if the internal current limit comparator input exceeds the 1.5V threshold, corresponding to 1.2A. When the current limit comparator is triggered, the HO and LO output pins immediately switches to the high impedance state.

The current sense signal provides the PWM comparator with a control signal that reaches 1.5V when the MOSFET current is 1.2A. To prevent erratic operation at low duty cycle, a leading edge blanking circuit attenuates the current sense signal for 100 ns when the power MOSFET is turned on. When the MOSFET is initially turned on, current spikes from the power MOSFET drain-source and gate-source capacitances flow through the current sense resistor. These transient currents normally cease within 50 ns with proper selection of rectifier diodes and proper PC board layout.

Thermal Protection

Internal Thermal Shutdown circuitry is provided to protect the IC in the event the maximum junction temperature is exceeded. When the 165°C junction temperature threshold is reached, the regulator is forced into a low power standby state, disabling all functions except the VCC regulator. Thermal hysteresis allows the IC to cool down by 25°C before it is re-enabled.

Power MOSFETs

The LM5015 switching regulator includes two N-Channel MOSFETs each with 450 m Ω nominal on-resistance. The drain of the high side MOSFET is the PVIN pin, and the source the HO pin. The drain of the low side MOSFET is the LO pin, and the source is internally connected to the PGND pin via the 42 m Ω internal current sense resistor. The on-resistance of the LM5015 MOSFETs varies with temperature as shown in the Typical Performance Characteristics graph. The typical gate charge for each MOSFETs is 4.5 nC which is supplied from the VCC and BST pins, respectively, when the MOSFETs are turned on.

The maximum duty cycle of the power MOSFETs is limited less than 50%. This is achieved by an oscillator divide-by-two circuit with an additional 50 ns of forced off-time introduced between the CLK and RS Flip-Flop. Consequently, the maximum duty cycle is limited by the following equation:

Duty_{Max_Limit}=(0.5 - 50 ns x F_{SW}) x 100%

Where F_{SW} is the switching frequency in Hertz (Hz). The purpose of limiting the maximum duty cycle less than 50% is to guarantee successful reset of the power transformer in the Two-Switch Forward converter topology. See applications information below for more detail.

Application Information

值加1005015"供应商 The following information is intended to provide guidelines for the power supply designer using the LM5015.

TWO-SWITCH FORWARD TOPOLOGY

Two-Switch Forward converter, like the conventional Single-Switch Forward converter, is derived from the Buck converter topology. The main difference between a Forward converter and a Buck is that a power transformer is introduced in the forward converter. The transformer realizes the input-output isolation, and the turns ratio provides a means to optimize the duty cycle for the particular input and output voltage requirements of the application.

The Two-Switch Forward converter employs two power MOS-FET switches instead of the one switch of the Single-Switch Forward converter. However the two-switch approach offers two major advantages over its single-switch counterpart:

 The voltage across the power MOSFET switches in a Two-Switch Forward converter is clamped to the input voltage, allowing the input voltage range to approach the rating of the MOSFETs. Whereas, the maximum operating voltage of a Single-Switch Forward converter is typically limited to half the MOSFET voltage rating.

2. The power transformer of a Two-Switch Forward converter is simpler, and hence costs less, than that of a Single-Switch Forward converter, because the Two-Switch converter transformer eliminates the tertiary reset winding that is normally required in the Single-Switch converter.

Figure 4 illustrates the Two-Switch Forward converter topology. The power circuit consists of an input capacitor C_{IN} , two MOSFET switches Q_H and Q_L , two clamp diodes D_H and D_L , a power transformer T_1 , two rectifier diodes D_1 and D_2 , an output inductor L_0 , and an output capacitor C_0 . Since the LM5015 integrates both Q_H and Q_L , a low cost Two-Switch Forward converter can be realized without a need for discrete power MOSFETs. With a slightly higher cost, the two rectifier diodes D_1 and D_2 on the secondary side of the power transformer can be replaced with synchronous rectifier MOSFETs to improve efficiency in applications with relatively low output voltage.

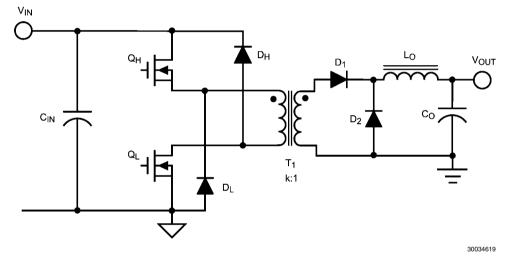


FIGURE 4. Two-Switch Forward Converter Topology

Figure 5 shows the two operating modes of the Two-Switch Forward Converter Approximation, the two MOSFETS are turned CON and OFF simultaneously. The output voltage is regulated by modulating the duty cycle of the MOSFETs. The relationship between the input voltage V_{IN} , output voltage V_{OUT} , duty cycle D, rectifier diode forward drop V_F , and transformer turns ratio k is defined by the following equation.

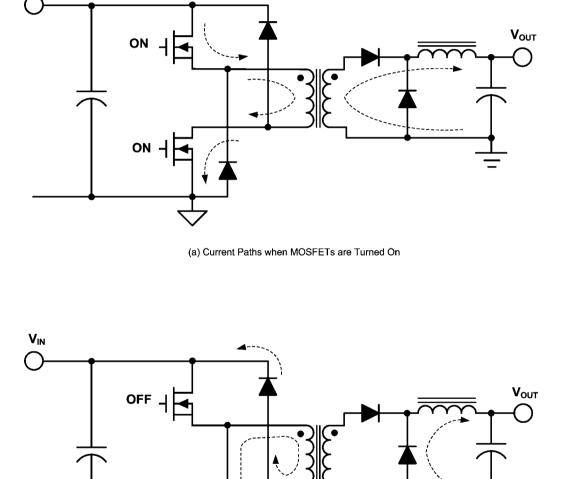
$$D = \frac{k x (V_{OUT} + V_F)}{V_{IN}}$$

When the MOSFETS are turned ON, as shown in Figure 5(a), the input voltage is applied to the power transformer primary.

OFF

VIN

The power transformer is magnetized by the application of the input voltage, and power flows to the secondary side circuit via transformer coupling. When the MOSFETS are turned OFF, as shown in Figure 5(b), the power flow to the primary is cut off. The residual magnetizing inductance of the power transformer reverses the voltage across the primary winding and forces the two clamp diodes D_H and D_L to conduct. This effectively clamps the MOSFETs voltage to the input voltage, and applies the input voltage in reversed polarity to the power transformer primary winding to demagnetize and reset the transformer.





(b) Current Paths when MOSFETs are Turned Off

Note that the power transformer primary receives the voltage the UN and OFF period of the power MOSFETs. In order to guarantee the volt-second balance between the magnetizing and demagnetizing intervals, the LM5015 limits the maximum duty cycle less than 50%. Therefore, an LM5015 Two-Switch Forward regulator always achieves a complete reset of the power transformer during each switching cycle.

The LM5015 can also be used to implement a Two-Switch Flyback regulator (Figure 14). The voltage across the MOS-

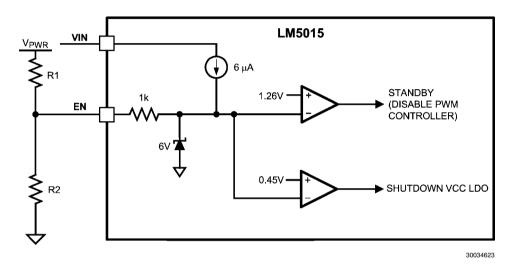
FETs employed in the Two-Switch Flyback converter is also clamped to the input voltage, allowing the input voltage range to approach the rating of the MOSFETs. Generally the Flyback converter is simpler and costs less than the Forward converter. However, the Flyback converter will have higher ripple current and voltages, and the conversion efficiency is typically lower.

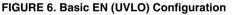
EN / UVLO VOLTAGE DIVIDER SELECTION

Two deacated control records and the EN pin are used to implement input under-voltage lockout and a shutdown condition. When the EN pin voltage is below 0.45V, the controller is in a low current shutdown mode where the VIN current is reduced to 110 µA. For an EN pin voltage greater than 0.45V but less than 1.26V the controller is in standby mode, with all internal circuits operational, but with the power MOSFETs disabled. Once the EN pin voltage is greater than 1.26V, the controller is fully enabled and the HO and LO outputs commence switching. Two external resistors can be used to program the minimum operational voltage for the power converter as shown in Figure 6. When the EN pin voltage falls below the 1.26V threshold, an internal 100 mV threshold hysteresis prevents noise from toggling the state. Therefore, the voltage at the EN pin must be reduced to 1.16V to transition to the standby state. Resistance values for R1 and R2 can be determined from the following equations, where V_{PWR} is the desired turn-on voltage and $I_{DIVIDER}$ is the user-defined current through R1 and R2.

$$R1 = \frac{V_{PWR} - 1.26V}{I_{DIVIDER}}$$
$$R2 = \frac{1.26V}{I_{DIVIDER} + 6 \mu A}$$

For example, if the LM5015 is to be enabled when V_{PWR} reaches 16V, I_{DIVIDER} could be chosen as 500 µA which would set R1 to 29.4 kΩ and R2 to 2.49 kΩ. If the voltage at the EN pin can exceed 6V, then the current into the 6V protection Zener must be limited below 4 mA by the external resistors. Be sure to check both the power and voltage rating for the selected R1 resistor (some 0603 resistors are rated as low as 50V maximum operating voltage).





A remote enable function can be accomplished with open drain device(s) connected to the EN pin as shown in Figure 7. A MOSFET or an NPN transistor connected to the EN pin will force the regulator into the low power 'off' state. Adding a PN diode in the drain (or collector) provides the offset to achieve the standby state. The advantage of standby is that the VCC LDO is not disabled and external circuitry powered by VCC remains functional.

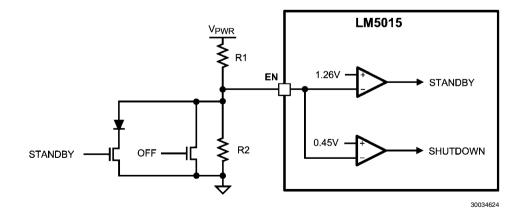


FIGURE 7. Remote Standby and Disable Control

-M5015

SOFT-START

follow the SS voltage under the control of the open-drain SS buffer amplifier. The C_{SS} capacitor will cause the COMP voltage to gradually increase, until the output voltage achieves regulation, and the error amplifier assumes control of the COMP and the PWM duty cycle. The C_{SS} capacitor continues charging by the internal 11 µA current source, preventing the SS voltage from interfering with the normal error amplifier function. During shutdown, the SS discharge MOSFET conducts to discharge the C_{SS} capacitor.

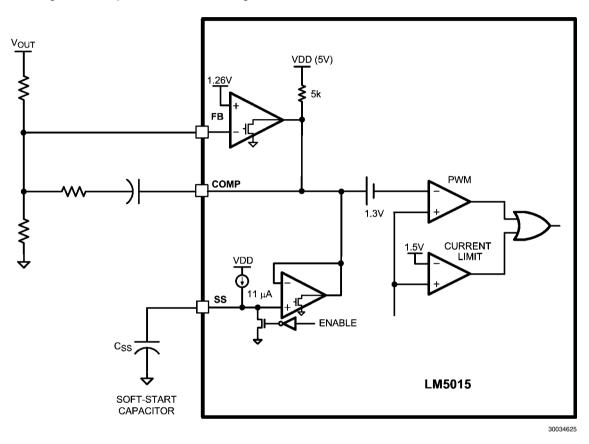


FIGURE 8. Soft-Start

CONVENTIONAL ISOLATED OUTPUT FEEDBACK DESIG暨询"LM5015"供应商

When isolation between the primary and secondary circuits is required, the internal error amplifier is usually disabled by connecting the FB pin to AGND, and an external error amplifier is employed on the secondary side of the isolation boundary. An opto-coupler is normally used to send the feedback signal across the isolation boundary, as shown in Figure 9. The LM5015 provides built-in pull-up for the collector of the opto-coupler at the COMP pin through a 5 k Ω internal resistor. Similar compensation network used in Figure 3 is applicable to the external, secondary-side error amplifier. The LM431A shown in Figure 9 provides both the voltage reference and error amplifier required to regulate the isolated output voltage.

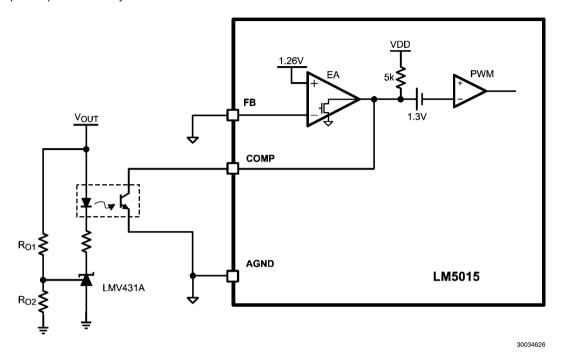


FIGURE 9. Conventional Isolated Feedback

HIGH BANDWIDTH ISOLATED FEEDBACK DESIGN USING THE CFB PIN

The LM5015 also includes a current mirror circuit for optional high bandwidth feedback loop design. As shown in Figure 10, the emitter of the opto-coupler transistor can be connected to the CFB pin, and the collector connected to VCC through an external 1 k Ω resistor. The 1 k Ω resistor to VCC is used to

protect the CFB pin by limiting the opto-coupler current to less than 10 mA. The 1 k Ω resistor from the opto-coupler collector to ground is introduced to protect the opto-coupler from excess voltage by limiting its V_{CE} to less than 50% of Vcc max. When the output voltage is below regulation, no current flows into the CFB pin and the PWM of the LM5015 operates at maximum duty cycle.

-M5015

≦询"LM5015"供应商

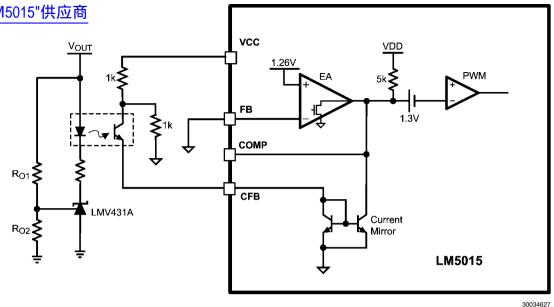


FIGURE 10. High bandwidth Isolated Feedback Using CFB Pin

The two external pull-up and pull-down resistors are effectively connected in parallel for ac signal, yielding a collector resistance on the opto-coupler of 0.5 k Ω . This resistance is 10 times smaller than the internal pull up resistor and the pole associated with the collector-base capacitance of the optocoupler transistor is pushed out to a decade higher frequency. Moving the opto-coupler pole to a higher frequency allows higher loop bandwidth capability than conventional isolated feedback designs (see Figure 9).

OUTPUT VOLTAGE

Output voltage is normally set with a resistor divider shown in Figure 11. To set the regulator's output voltage to V_O, the two resistors must satisfy the following equation:

$$\frac{R_{O2}}{R_{O1}} = \frac{V_{REF}}{V_{O} - V_{REF}}$$

where V_{RFF} is the reference voltage of the error amplifier, which is 1.26V for the LM5015's internal error amplifier.

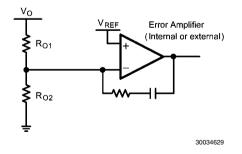


FIGURE 11. Output Voltage Setting

In isolated designs, the reference and error amplifier are located on the secondary side. To obtain a 5V output in an isolated feedback design using LMV431A (whose nominal V_{BEE} is1.24V), the feedback divider resistors ratio specified by above equation is 0.330. Selecting 24.3 k Ω for R_{Ω 1}, then $R_{\Omega 2}$ should be 8.06 k Ω . In a similar non-isolated converter design using the internal error amplifier, the divider's resistors ratio is 0.337, therefore if 24.3 k Ω is selected for R₀₁, then $R_{\Omega 2}$ should be 8.20 k Ω .

Multiple resistors in series or parallel combinations for either R₀₁, or R₀₂, or both, may be necessary to set a required output voltage. Note that the accuracy of the output voltage setting is determined by the tolerance of the divider resistors as well as the accuracy of $\mathrm{V}_{\mathrm{REF}}$. The accuracy of the LM5015 internal V_{BEE} is 1.5%, and the most popular chip resistors have a tolerance of 1%, therefore the achievable output accuracy with the internal error amplifier and 1% resistors is about 2.5%. To achieve better output voltage accuracy, use an external voltage reference with higher precision and resistors of tighter tolerance, such as the 0.1%, resistors for R_{O1} and R_{O2}.

PRINTED CIRCUIT BOARD LAYOUT

The LM5015 Current Sense and PWM comparators are very fast and may respond to short duration noise pulses. The components at the HO, LO, COMP, EN, VCC and the RT pins should be as physically close as possible to the IC, thereby minimizing noise pickup on the PC board tracks. The HO and LO output pins of the LM5015 should have short, wide conductors to the power path inductors, transformers and capacitors in order to minimize parasitic inductance that reduces efficiency and increases conducted and radiated noise. Ceramic decoupling capacitors are recommended between the VIN pin to the AGND pin, between the PVIN pin and PGND pin, and between the VCC pin to the AGND pin. Use short, direct connections to avoid clock jitter due to ground voltage differentials. Small package surface mount X7R or X5R capacitors are preferred for high frequency performance and limited variation over temperature and applied voltage.

If an application using the LM5015 produces high junction temperatures during normal operation, multiple vias from the exposed metal pad on the underside of the IC package to a PC board ground plane will help conduct heat away from the

IC. Judicious positioning of the PC board within the end product, along high use of poy (and the air flow will help reduce the junction temperature. If using forced air cooling, avoid placing the LM5015 in the airflow shadow of large components, such as input or output capacitors, inductors or transformers.

Application Examples

The following schematics present four examples dc-dc converters utilizing the LM5015 switching regulator IC:

- 1. Non-Isolated Two-Switch Forward for 48V input and 5V 2.5A output,
- 2. Isolated Two-Switch Forward for 48V input and 5V 2.5A output
- 3. Isolated Two-Switch Flyback converter for 48V input and 5V 2.5A output,

4. A 1:1 dc-dc transformer with the input/output operating range of 5V to 15V

48V NON-ISOLATED TWO-SWITCH FORWARD

The Non-Isolated Two-Switch Forward converter shown in Figure 12 utilizes the internal voltage reference for the regulation set-point. The output is +5V at 2.5A while the input voltage can vary from 36V to 72V. The switching frequency is 300 kHz. An auxiliary winding on transformer (T1) provides 10V to power the LM5015 when the output is in regulation. This disables the internal high voltage VCC LDO regulator and improves efficiency. The converter can be shut down by driving the EN input below 1.26V with an open-collector or open-drain transistor. An external synchronizing frequency can be applied to the SYNC input.

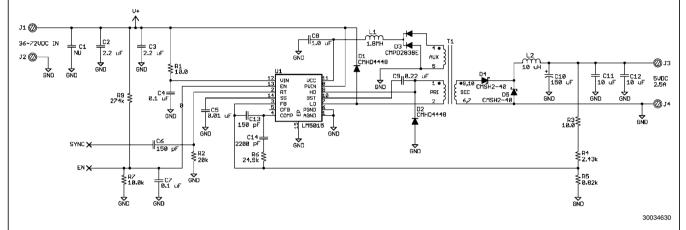


FIGURE 12. Non-Isolated Two-Switch Forward

-M5015

48V ISOLATED TWO-SWITCH FORWARD

 coupler LED, which sets the COMP pin voltage. The output is +5V at 2.5A and the input voltage ranges from 36V to 72V. The switching frequency is 300 kHz. The functions of the EN and SYNC inputs are the same as in the previous example circuit.

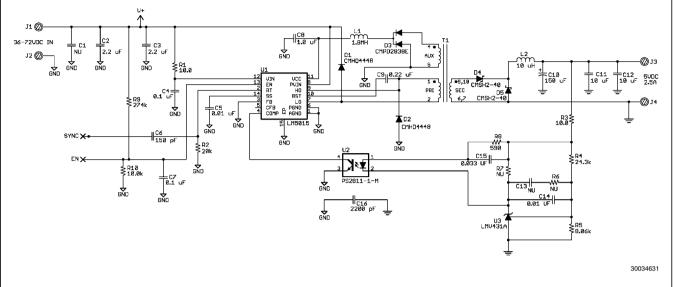
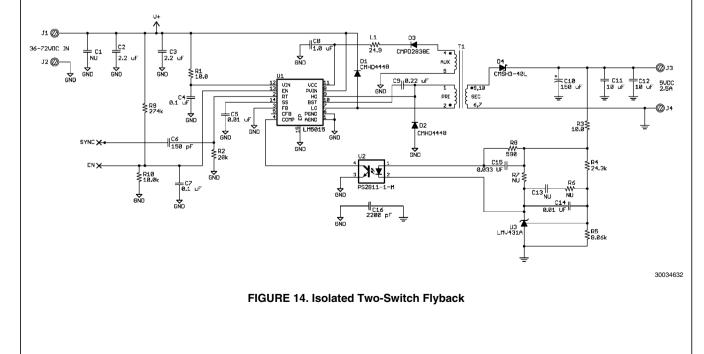


FIGURE 13. Isolated Two-Switch Forward

ISOLATED TWO-SWITCH FLYBACK

The Isolated Two-Switch Flyback converter shown in Figure 14 utilizes a 1.24V voltage reference (LMV431A) located on the isolated secondary side for the regulation set-point. The LM5015 internal error amplifier is disabled by grounding the FB pin. The LMV431A controls the current through the optocoupler LED, which sets the COMP pin voltage. The output is +5V at 2.5A and the input voltage ranges from 36V to 72V. The switching frequency is 300 kHz. The Flyback converter is less complex than the previous Forward converter example in Figure 13. However, the Flyback converter produces higher input and output ripples of voltage and currents, and lower conversion efficiency by about 2%. The functions of the EN and SYNC inputs are the same as in the previous example circuits.

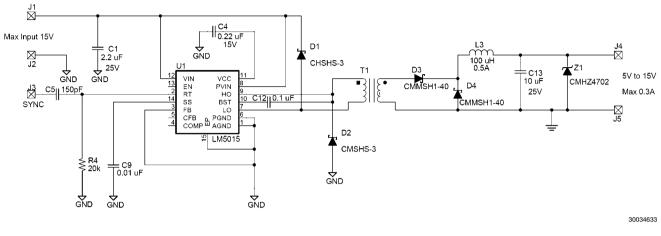
This circuit can be used with the LM5073 for a low cost isolated Power over Ethernet (PoE) Power Device (PD) application that does not require a discrete power MOSFET.



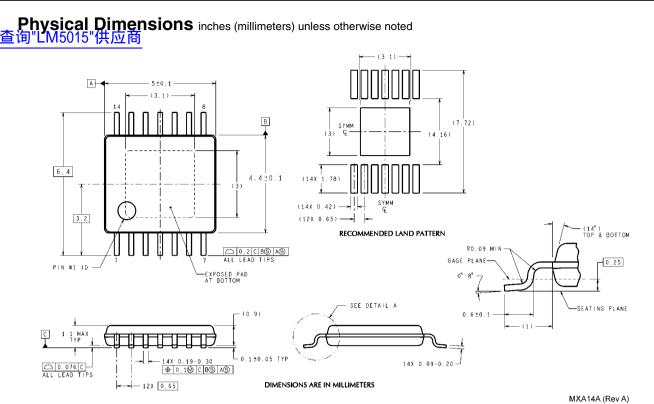
DC-DC TRANSFORMER

The DCD THE DC

output voltage will be approximately equal to the input voltage. A Zener diode Z1 is used at the output rail as a simple means to protect the output against over-voltage under light and no load conditions. The maximum load of this example circuit is 0.3A, and the operating voltage range is from 5V to 15V.







14-Lead Exposed Pad Package NS Package Number MXA14A

查询"LM5015"供应商

Notes

查询"LM5015"供应商

Notes

For more National Semiconductor product information and proven design tools, visit the following Web sites at:

Products		Design Support		
Amplifiers	www.national.com/amplifiers	WEBENCH® Tools	www.national.com/webench	
Audio	www.national.com/audio	App Notes	www.national.com/appnotes	
Clock and Timing	www.national.com/timing	Reference Designs	www.national.com/refdesigns	
Data Converters	www.national.com/adc	Samples	www.national.com/samples	
Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards	
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage Reference	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Solutions	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
Temperature Sensors	www.national.com/tempsensors	Solar Magic®	www.national.com/solarmagic	
Wireless (PLL/VCO)	www.national.com/wireless	Analog University®	www.national.com/AU	

THE CONTENTS OF THIS DOCUMENT ARE PROVIDED IN CONNECTION WITH NATIONAL SEMICONDUCTOR CORPORATION ("NATIONAL") PRODUCTS. NATIONAL MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE ACCURACY OR COMPLETENESS OF THE CONTENTS OF THIS PUBLICATION AND RESERVES THE RIGHT TO MAKE CHANGES TO SPECIFICATIONS AND PRODUCT DESCRIPTIONS AT ANY TIME WITHOUT NOTICE. NO LICENSE, WHETHER EXPRESS, IMPLIED, ARISING BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT.

TESTING AND OTHER QUALITY CONTROLS ARE USED TO THE EXTENT NATIONAL DEEMS NECESSARY TO SUPPORT NATIONAL'S PRODUCT WARRANTY. EXCEPT WHERE MANDATED BY GOVERNMENT REQUIREMENTS, TESTING OF ALL PARAMETERS OF EACH PRODUCT IS NOT NECESSARILY PERFORMED. NATIONAL ASSUMES NO LIABILITY FOR APPLICATIONS ASSISTANCE OR BUYER PRODUCT DESIGN. BUYERS ARE RESPONSIBLE FOR THEIR PRODUCTS AND APPLICATIONS USING NATIONAL COMPONENTS. PRIOR TO USING OR DISTRIBUTING ANY PRODUCTS THAT INCLUDE NATIONAL COMPONENTS, BUYERS SHOULD PROVIDE ADEQUATE DESIGN, TESTING AND OPERATING SAFEGUARDS.

EXCEPT AS PROVIDED IN NATIONAL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, NATIONAL ASSUMES NO LIABILITY WHATSOEVER, AND NATIONAL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY RELATING TO THE SALE AND/OR USE OF NATIONAL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

National Semiconductor and the National Semiconductor logo are registered trademarks of National Semiconductor Corporation. All other brand or product names may be trademarks or registered trademarks of their respective holders.

Copyright© 2009 National Semiconductor Corporation

For the most current product information visit us at www.national.com



National Semiconductor Americas Technical Support Center Email: support@nsc.com Tel: 1-800-272-9959 National Semiconductor Europe Technical Support Center Email: europe.support@nsc.com German Tel: +49 (0) 180 5010 771 English Tel: +44 (0) 870 850 4288 National Semiconductor Asia Pacific Technical Support Center Email: ap.support@nsc.com National Semiconductor Japan Technical Support Center Email: jpn.feedback@nsc.com